

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| In re Application of: Lin et al. | Group Art Unit: Unknown |
| Application No: 10/691,418 | Examiner: Unknown |
| Confirmation No: Unknown | Attorney Docket No: |
| Filed: 10/22/2003 | 008716 USA/CPS/IBSS/LAP |
| Title: CLEANING AND REFURBISHING CHAMBER COMPONENTS HAVING METAL COATINGS | January 27, 2004 San Francisco, California |

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Non Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir/Madam:

Attached hereto is a form listing documents believed relevant to the subject application. It is respectfully requested that these documents be considered by the Examiner and an initialed copy of the form be returned to the undersigned.

Applicant believes this Information Disclosure Statement should be considered by the Office because it is being filed before the mailing of a first Office Action on the merits.

It is believed that no fee is due for the filing of this Information Disclosure Statement. However, if any fee is due, the Commissioner is hereby authorized to charge payment of any such fees to Deposit Account No. 10-0258.

Also, if any Petition is required for the filing of this Information Disclosure Statement, such Petition is requested herein.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Non Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, or facsimile transmitted to the U.S. Patent and Trademark Office at (703) _____ on the date shown below.

By:

Rowena Montoya

Date:

1/27/2004

It is believed that this disclosure complies with the requirements of 37 C.F.R. §§ 1.56, 1.97, and 1.98, and the Manual of Patent Examining Procedures §707.05(b). If for some reason the Examiner considers otherwise, it is respectfully requested that the undersigned be called so that any deficiencies can be remedied.

A copy of each document is enclosed.

Some of the documents may have markings thereon. No significance is meant to be attached to the markings.

With regard to any translations which may be provided herewith, the undersigned does not know how the translations were made, or by whom the translations were made. Therefore, no representation is being made as to the accuracy of any translation.

These documents are not necessarily analogous.

Respectfully submitted,
JANAH & ASSOCIATES, P.C.

Date: 1/27/2004

By: 

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Please direct all telephone calls to:

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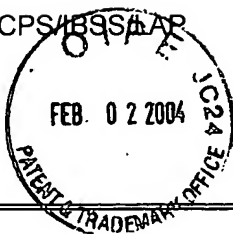
Please continue to send all correspondence to:

Applied Materials, Inc.
Patent Department, M/S 2061
P.O. Box 450A
Santa Clara, CA 95052

Encl.

PENDING U.S. PATENT APPLICATIONS

ATTORNEY DOCKET NO.: 008716 USA/CPS/HSS/AP
SERIAL NUMBER: 10/691,418
FILING DATE: 10/22/2003
INVENTORS: Lin, et al.



| EXAMINER INITIAL | | PENDING U.S. PATENT APPLICATIONS |
|---------------------|-----|---|
| | D1 | U.S. Patent Application entitled, "PARTICLE REMOVAL FROM PVD CHAMBER COMPONENTS WITH HIGH PRESSURE WATER"; filed September 2, 2003; Serial No. 10/653,713; Inventors: West et al. |
| | D2 | U.S. Patent Application entitled, "METHOD OF CLEANING A COATED PROCESS CHAMBER COMPONENT"; filed November 25, 2002; Serial No. 10/304,535; Inventors: Wang et al.. |
| | D3 | |
| | D4 | |
| | D5 | |
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